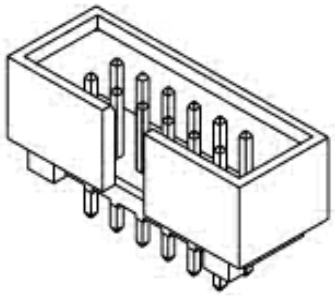
Part Number : 702463001
Product Description : 2.54mm Pitch C-Grid Header, Low Profile, Dual Row, Vertical, Shrouded, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Series Number : 70246
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

702463001_sd.pdf

PK-87835-001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

713080001-AS-000.pdf

PS-70246-100-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)

EU RoHS	Compliant per EU 2015/863

Compliance Statements
- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	70246
Description	2.54mm Pitch C-Grid Header, Low Profile, Dual Row, Vertical, Shrouded, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	822348487516

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	2.5A

Voltage - Maximum	250V DC

Physical

Breakaway	No
Circuits (Loaded)	30
Circuits (maximum)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Net Weight	3.607/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	3.43mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	Center Slot
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +120°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	10

Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	235

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	71395
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	71850
SL Dual Row Crimp Housings	70450